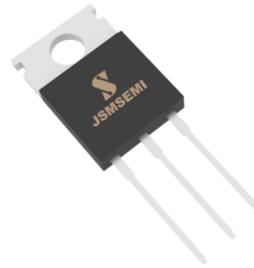


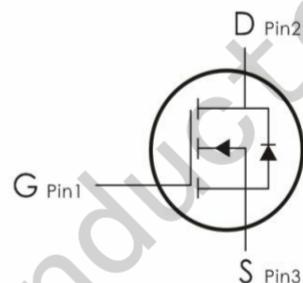
## FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



## APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



Device Marking and Package Information		
Device	Package	Marking
IRF3710PBF	TO-220	IRF3710

## Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Value	Unit
		TO-220	
Drain-Source Voltage ( $V_{GS} = 0\text{V}$ )	$V_{DSS}$	100	V
Continuous Drain Current	$I_D$	60	A
Pulsed Drain Current (note1)	$I_{DM}$	230	A
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V
Single Pulse Avalanche Energy (note2)	$E_{AS}$	1943	mJ
Avalanche Current (note1)	$I_{AR}$	32	A
Repetitive Avalanche Energy (note1)	$E_{AR}$	36	mJ
Power Dissipation ( $T_C = 25^\circ\text{C}$ )	$P_D$	200	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to 175	$^\circ\text{C}$

## Thermal Resistance

Parameter	Symbol	Value	Unit
		TO-220	
Thermal Resistance, Junction-to-Case	$R_{thJC}$	0.75	
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	62	$^\circ\text{C}/\text{W}$

**Specifications  $T_J = 25^\circ\text{C}$ , unless otherwise noted**

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 25^\circ\text{C}$	--	--	1	$\mu\text{A}$
		$V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$	--	--	100	
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{\text{GS}} = +20\text{V}, V_{\text{DS}} = 0\text{V}$	--	--	100	nA
		$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$	--	--	-100	
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.0	--	4.0	V
Drain-Source On-Resistance (Note3)	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 28\text{A}$	--	17	21	$\text{m}\Omega$
Forward Transconductance	$g_{\text{fs}}$	$V_{\text{DS}} = 10\text{V}, I_D = 28\text{A}$		85		S
<b>Dynamic</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1.0\text{MHz}$	--	2700	--	pF
Output Capacitance	$C_{\text{oss}}$		--	610	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	260	--	
Total Gate Charge	$Q_g$	$V_{\text{DD}} = 50\text{V}, I_D = 28\text{A}, V_{\text{GS}} = 0 \text{ to } 10\text{V}$	--	60	--	nC
Gate-Source Charge	$Q_{\text{gs}}$		--	15	--	
Gate-Drain Charge	$Q_{\text{gd}}$		--	45	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 50\text{V}, I_D = 28\text{A}, V_{\text{GS}} = 10\text{V}, R_G = 2.5\Omega$	--	20	--	ns
Turn-on Rise Time	$t_r$		--	28	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	65	--	
Turn-off Fall Time	$t_f$		--	15	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	60	A
Pulsed Diode Forward Current	$I_{\text{SM}}$		--	--	230	
Body Diode Voltage	$V_{\text{SD}}$	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 28\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	1.5	V
Reverse Recovery Time	$t_{\text{rr}}$	$V_{\text{GS}} = 0\text{V}, I_S = 28\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$	--	195	--	ns
Reverse Recovery Charge	$Q_{\text{rr}}$		--	107	--	$\mu\text{C}$

**Notes**

- Repetitive Rating: Pulse width limited by maximum junction temperature
- $I_{AS} = 30\text{A}, V_{\text{DD}} = 50\text{V}, R_G = 25\Omega, \text{Starting } T_J = 25^\circ\text{C}$
- Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 1\%$

**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

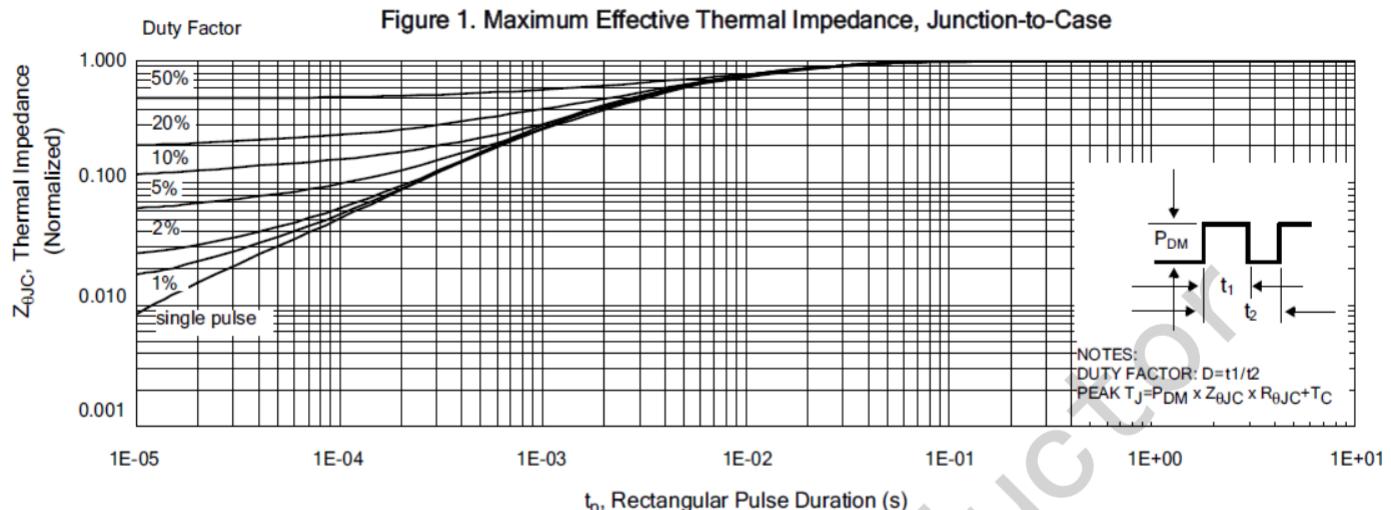


Figure 2. Maximum Power Dissipation vs Case Temperature

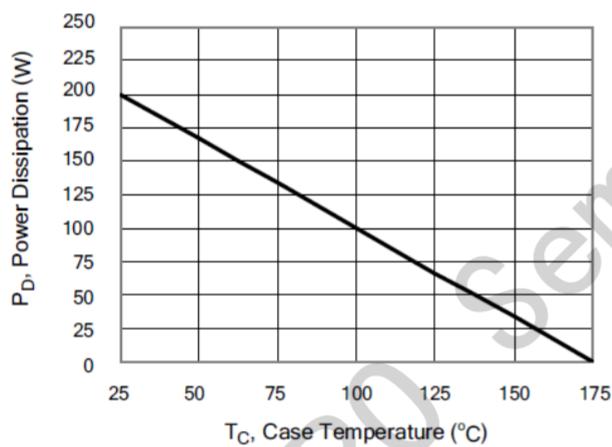


Figure 4. Typical Output Characteristics

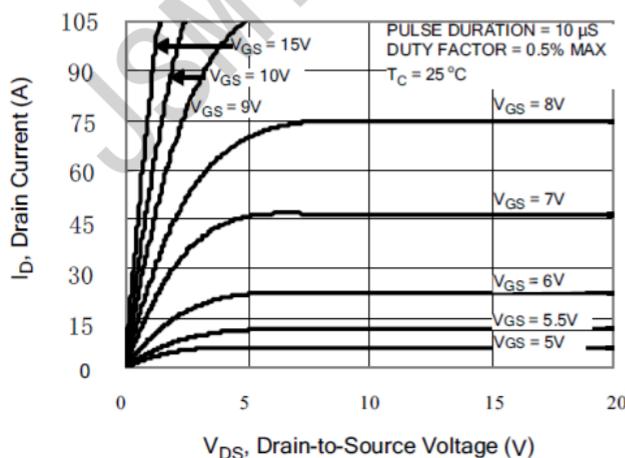


Figure 3. Maximum Continuous Drain Current vs Case Temperature

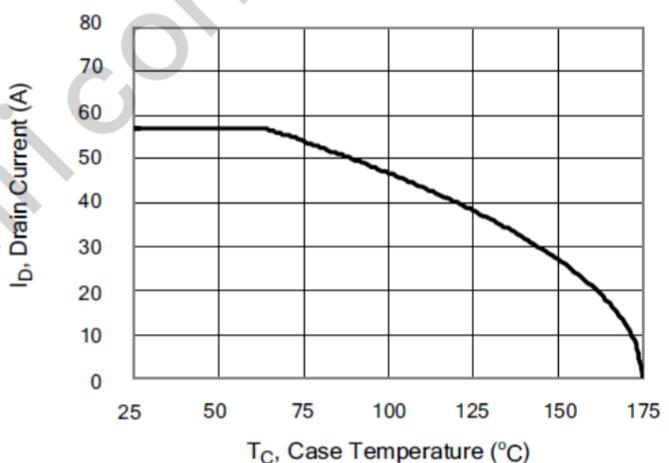
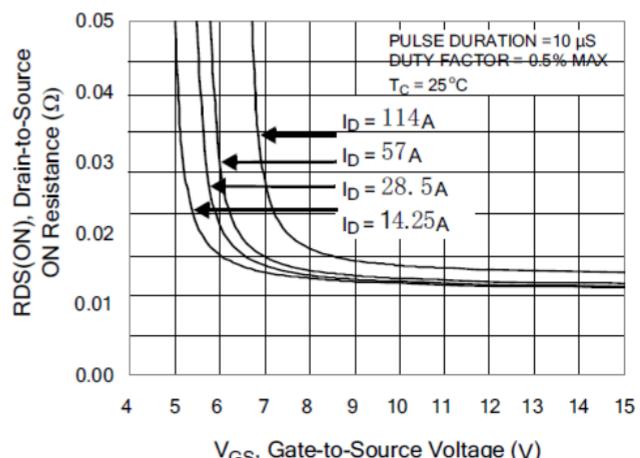


Figure 5. Typical Drain-to-Source ON Resistance vs Gate Voltage and Drain Current



**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 6. Maximum Peak Current Capability

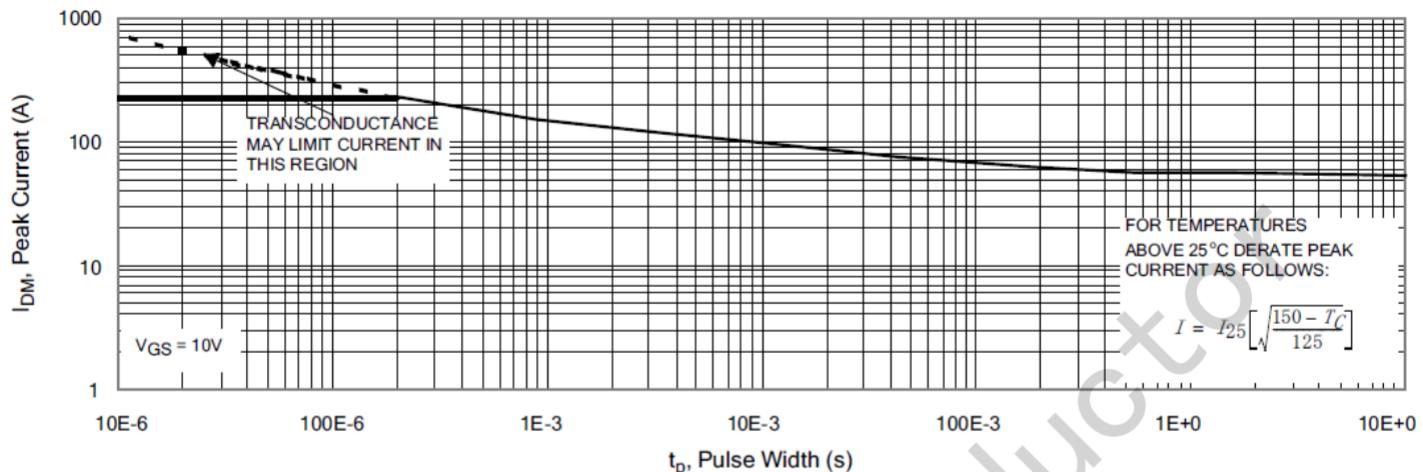


Figure 7. Typical Transfer Characteristics

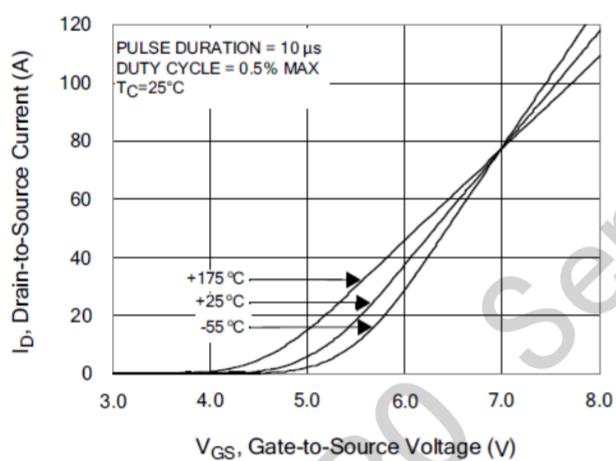


Figure 8. Unclamped Inductive Switching Capability

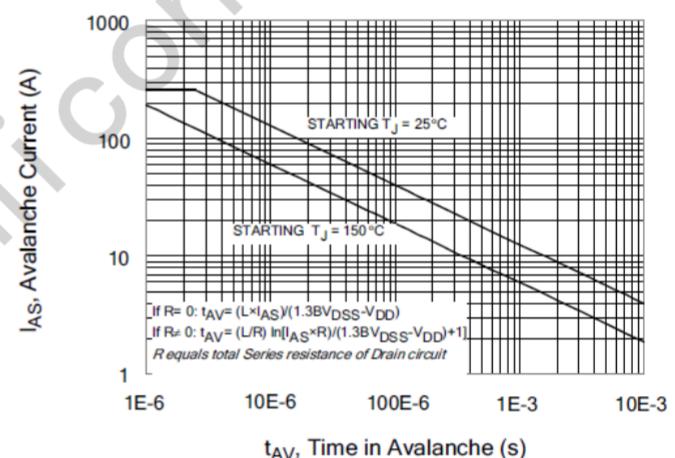


Figure 9. Typical Drain-to-Source ON Resistance vs Drain Current

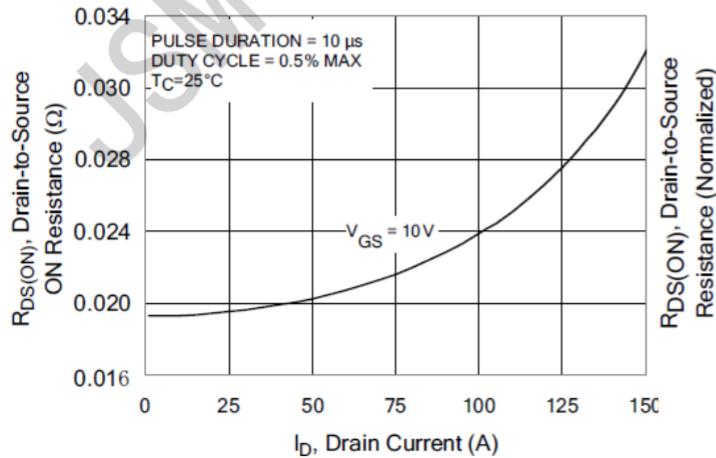
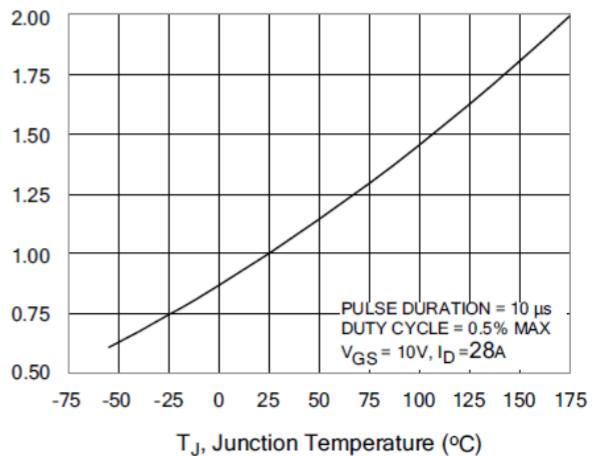


Figure 10. Typical Drain-to-Source ON Resistance vs Junction Temperature



**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 11. Typical Breakdown Voltage vs Junction Temperature

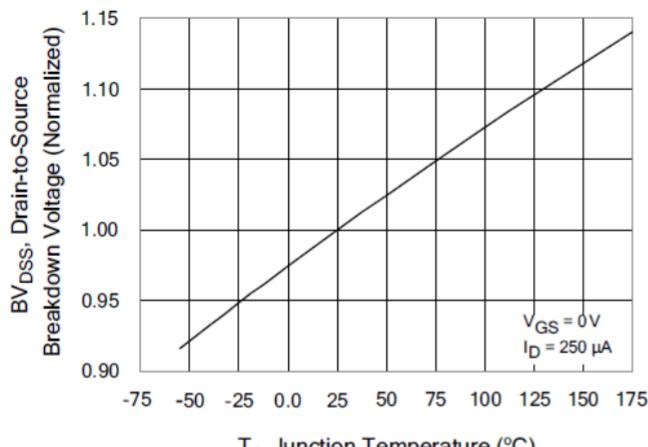


Figure 13. Maximum Forward Bias Safe Operating Area

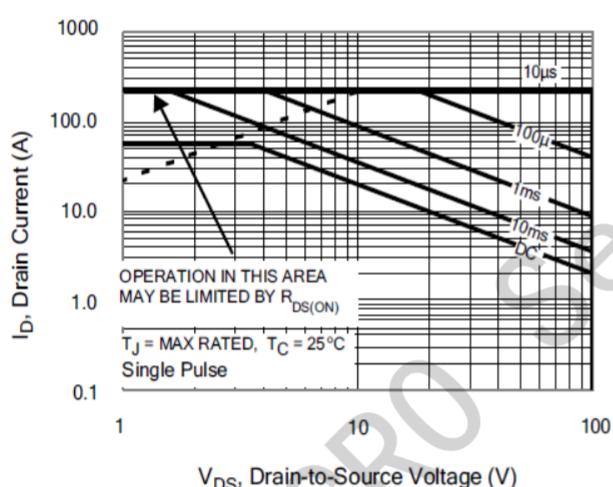


Figure 15. Typical Gate Charge

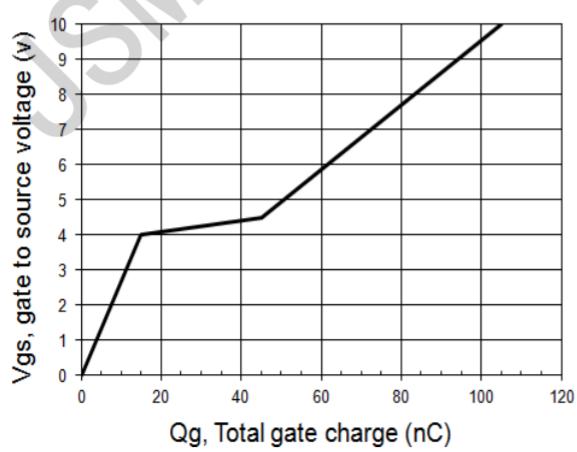


Figure 12. Typical Threshold Voltage vs Junction Temperature

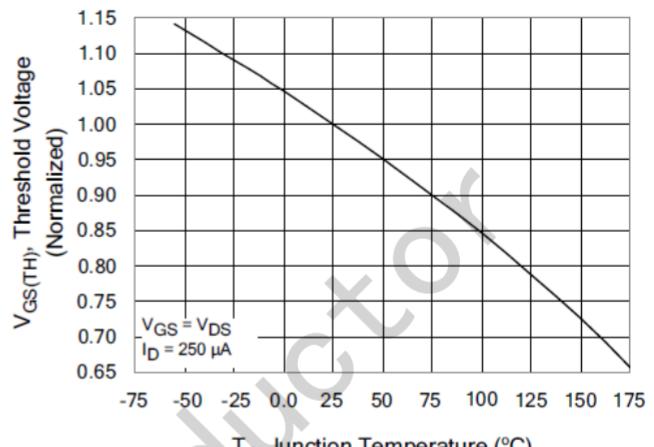


Figure 14. Capacitance vs Vds

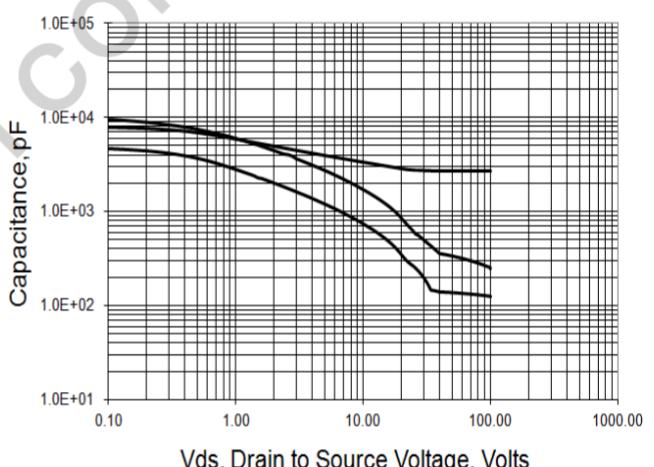
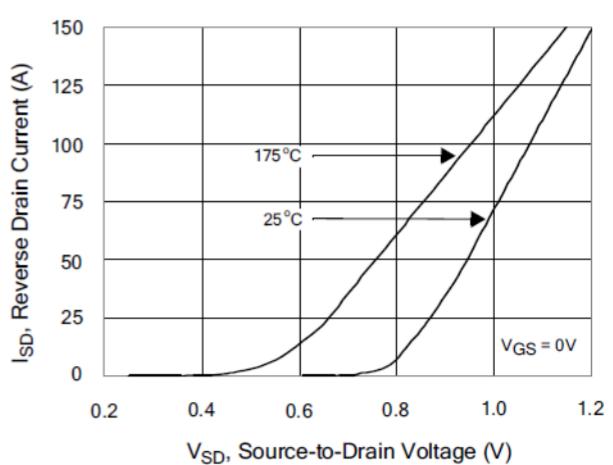
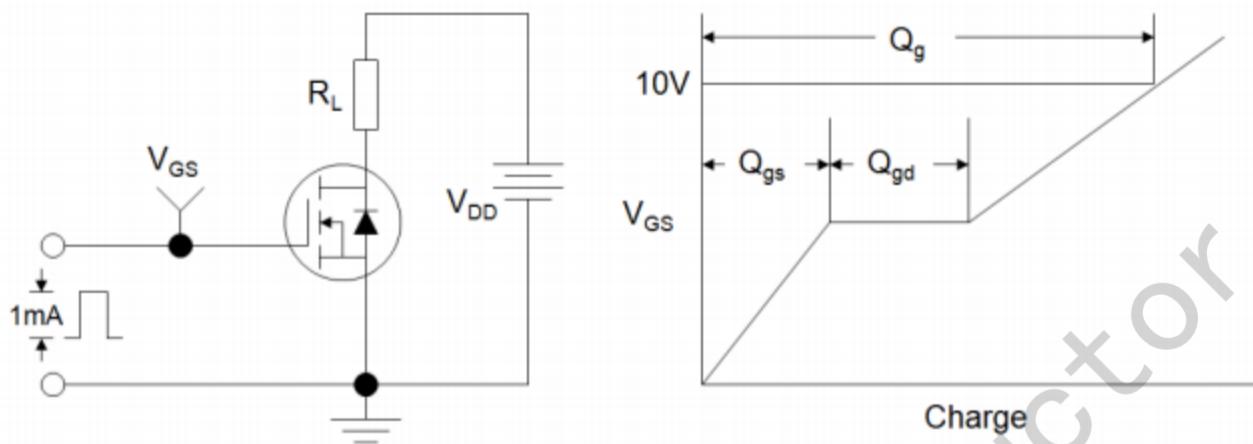
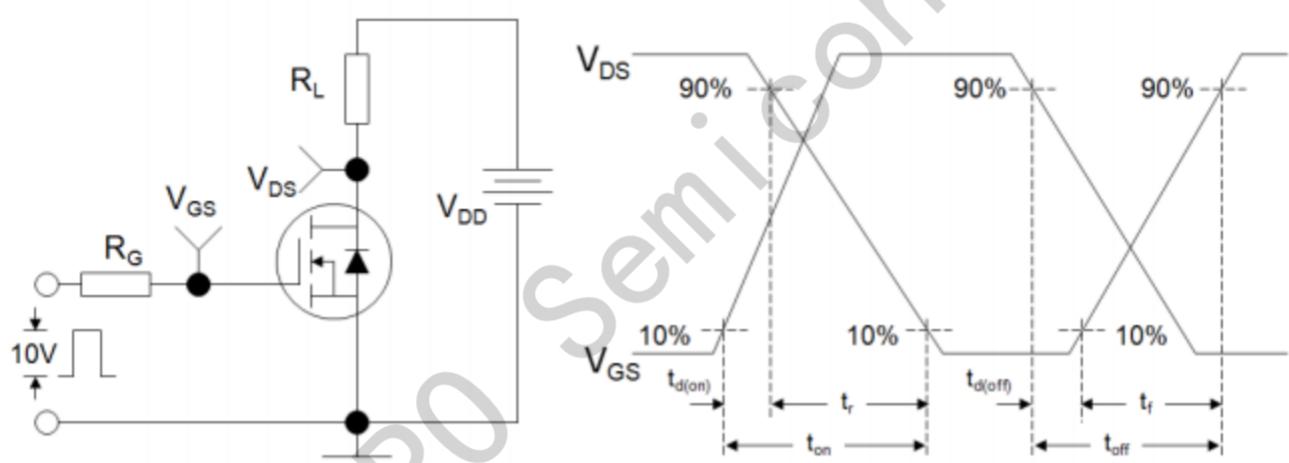
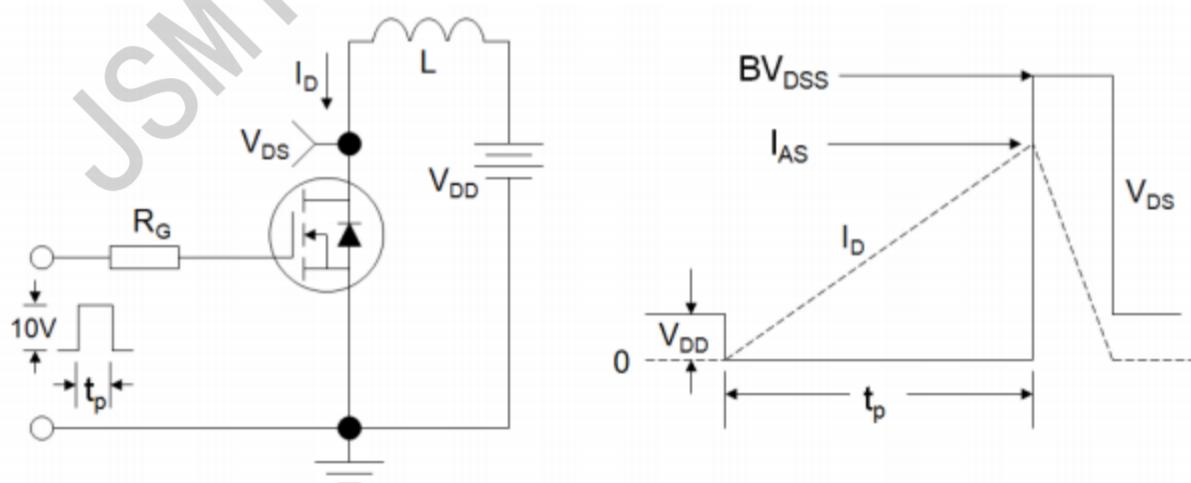


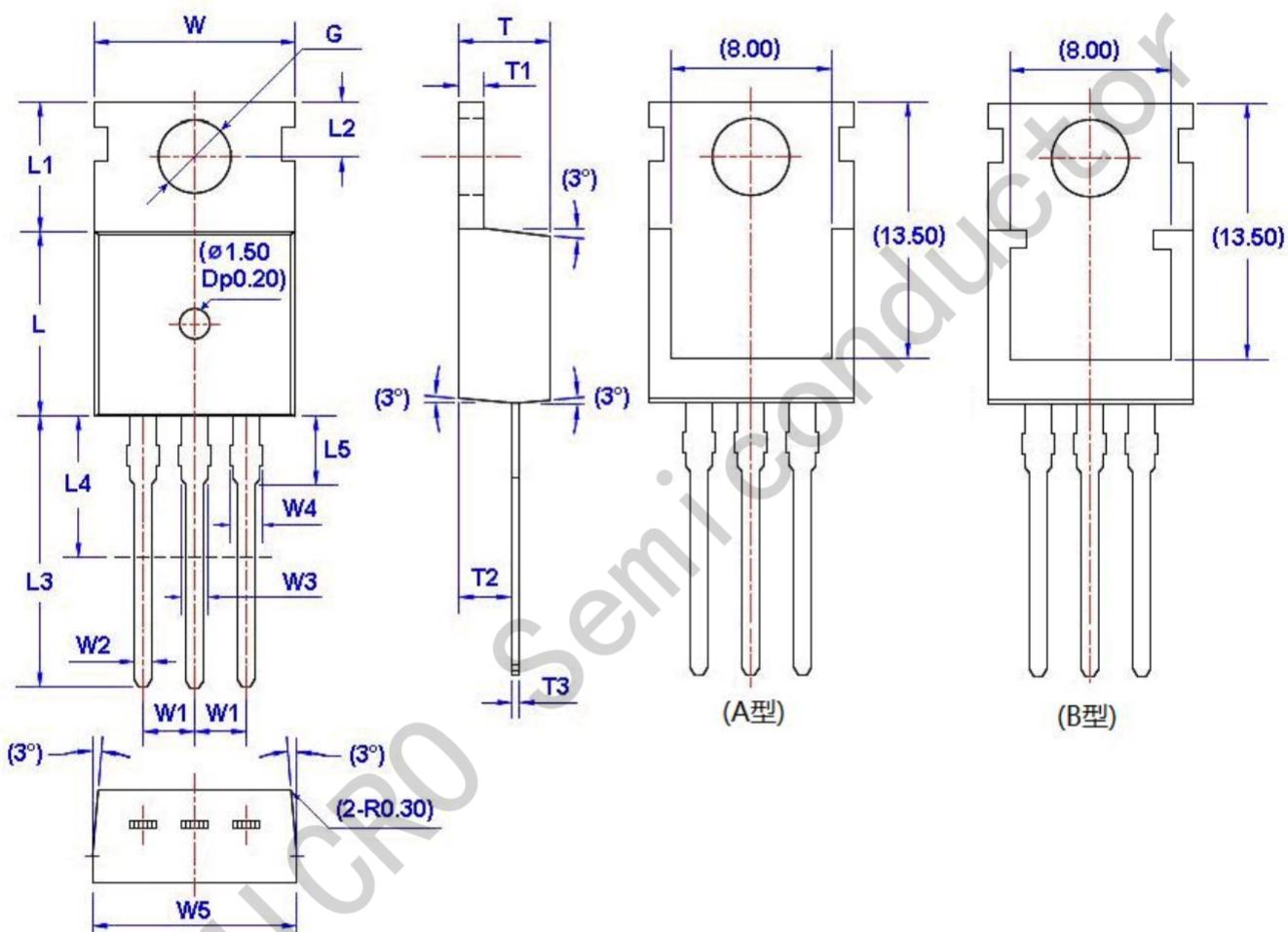
Figure 16. Typical Body Diode Transfer Characteristics



**Figure A: Gate Charge Test Circuit and Waveform**

**Figure B: Resistive Switching Test Circuit and Waveform**

**Figure C: Unclamped Inductive Switching Test Circuit and Waveform**


## Package Information

TO-220



Unit: mm

Symbol	Size		Symbol	Size		Symbol	Size		Symbol	Size	
	Min	Max		Min	Max		Min	Max		Min	Max
W	9.66	10.28	W5	9.80	10.20	L4**	6.20	6.60	T3	0.45	0.60
W1	2.54 (TYP)		L	9.00	9.40	L5	2.79	3.30	G( $\Phi$ )	3.50	3.70
W2	0.70	0.95	L1	6.40	6.80	T	4.30	4.70			
W3	1.17	1.37	L2	2.70	2.90	T1	1.15	1.40			
W4*	1.32	1.72	L3	12.70	14.27	T2	2.20	2.60			